

# Product/Process Change (PCN) Notification

PCN Number: CO-17633	Contact: Elizabeth La Greca	
Date Issued: Jul 11 <sup>th</sup> , 2017	Title: Director, Sales Operations	
PCN Effective Date: Oct 11 <sup>th</sup> , 2017	Phone: 858-255-7839	
Product(s) Affected: PE43712	Email: PCN@psemi.com	
Sample Availability: Jul 25 <sup>st</sup> , 2017		
Change Control Board Approval #: CO-17633		
Change Category:		
Wafer Fabrication Process - Dual Source	Shipping/Labeling	
Design/Mask Change	Equipment	
Singulation Process	Material	
Assembly Process	Product Specification	
Electrical Test	Product End of Life	
Manufacturing Site	🛛 Other - Ordering Code	

### Purpose of Change:

To enable MagnaChip and Lapis as dual source wafer fabrication sites

#### **Description of Change:**

MagnaChip closed their 150 mm wafer CMOS fab in South Korea at the end of 2015. To ensure there is no disruption to supply, we have been working to transfer products from MagnaChip fab to Lapis fab in Japan. Magnachip and Lapis are qualified Peregrine fabs.

Lapis PE43712 material has been qualified with no change to form, fit, function or reliability. Beginning Oct 11<sup>th</sup>, 2017, the PE43712 shipped to customers will be supplied from either MagnaChip or Lapis wafers.

Ordering codes: (Original) MagnaChip part number: PE43712A-Z, EK43712-02 (New) Lapis part number: PE43712B-Z, EK43712-03

For more information, please contact PCN@psemi.com.



## Product/Process Change (PCN) Notification

#### Customer Acknowledgement of Receipt\*:

Change Denied	Name:	
(Include explanation in comments section below)	Title:	
Change Approved	Company:	
	Date:	
	Signature:	
Customer Comments:		